



N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$ $I_{D}(A)$		Q _g (Typ.)	
30	0.0039 at V _{GS} = 10 V	107 ^d	67	
	0.0045 at $V_{GS} = 4.5 \text{ V}$	103 ^d	07	

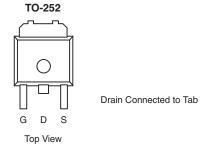
FEATURES

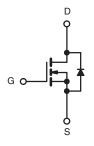
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- DC/DC Converters
 - Synchronous Buck Low Side





Ordering Information: SUD42N03-3m9P-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

	RATINGS ($T_C = 25 ^{\circ}C$, unless other	· · · · · · · · ·		·	
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V_{DS}	30	V		
Gate-Source Voltage		V_{GS}			± 20
Continuous Drain Current	T _C = 25 °C (Silicon Limited)		107 ^d		
	T _C = 70 °C (Silicon Limited)	I _D	85 ^d	Α	
	T _C = 25 °C (Package Limited)] [42		
Pulsed Drain Current (t = 300 μs)	I _{DM}	120			
Avalanche Current	I _{AS}	45			
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	101	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	В	73.5 ^b	W	
	T _A = 25 °C ^c	P _D	2.5		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	- °C/W		
Junction-to-Case (Drain)	R _{thJC}	1.7			

Notes

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 42 A.

SUD42N03-3m9P

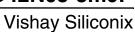
Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	V _{DS} = 0 V, I _D = 250 μA	30			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		2.5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA	
Zero Gate Voltage Drain Current		V _{DS} = 30 V, V _{GS} = 0 V			1		
	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 150 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
		V _{GS} = 10 V, I _D = 22 A		0.0032	0.0039	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 20 A		0.0037	0.0045		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		110		S	
Dynamic ^b							
Input Capacitance	C _{iss}			3535		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 15 \text{ V}, f = 1 \text{ MHz}$		680			
Reverse Transfer Capacitance	C _{rss}			400			
Total Gate Charge ^c	Qg			67	100	nC	
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		10.5			
Gate-Drain Charge ^c	Q_{gd}			12.2			
Gate Resistance	R_{g}	f = 1 MHz	0.3	1.4	2.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}			11	20		
Rise Time ^c	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		10	20	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		35	53		
Fall Time ^c	t _f			10	20		
Drain-Source Body Diode Ratings at	nd Characteris	stics ^b T _C = 25 °C	•	•			
Continuous Current	I _S				42	۸	
Pulsed Current	I _{SM}				120	A	
Forward Voltage ^a	V_{SD}	I _F = 10 A, V _{GS} = 0 V		0.83	1.5	٧	
Reverse Recovery Time	t _{rr}			41	62	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	$I_F = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		2	3	Α	
Reverse Recovery Charge	Q _{rr}			40	60	nC	

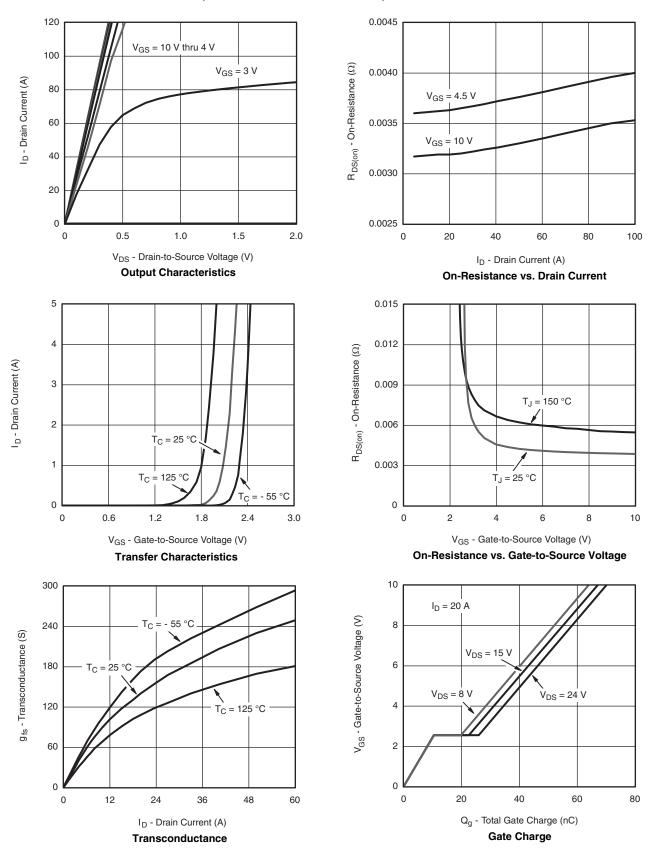
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



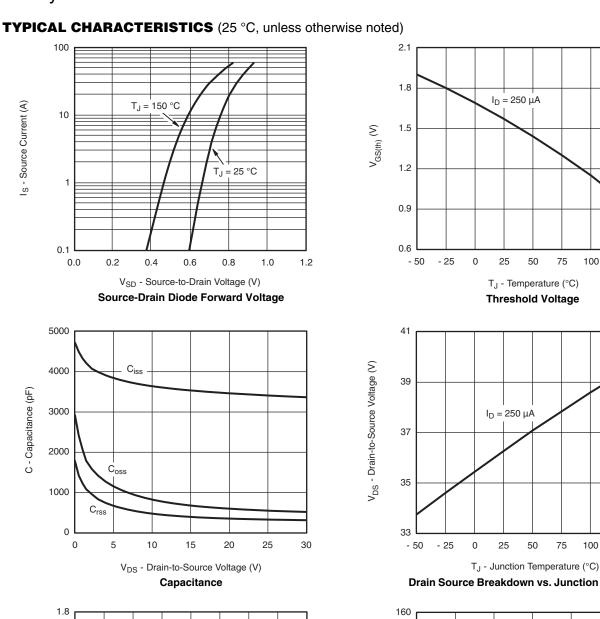


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

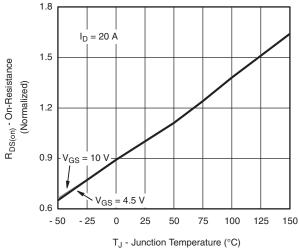


SUD42N03-3m9P

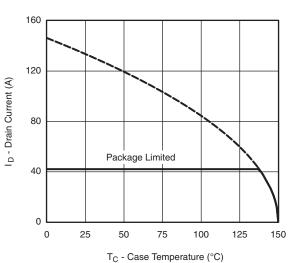
Vishay Siliconix









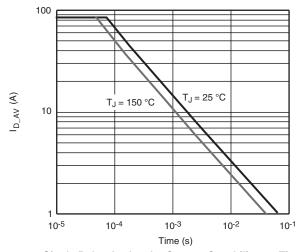


Current Derating

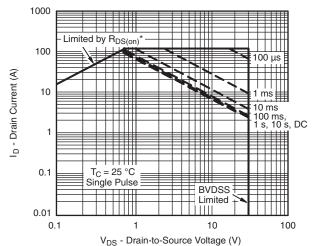


Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

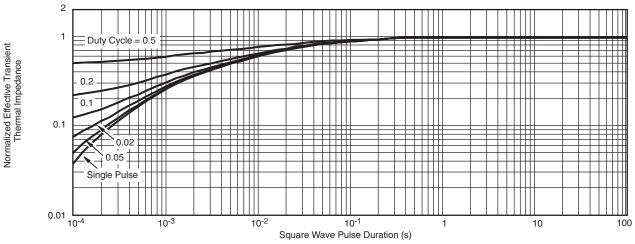


Single Pulse Avalanche Current Capability vs. Time



 * V $_{GS}$ > minimum V $_{GS}$ at which R $_{DS(on)}$ is specified





Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?66824.



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay:

SUD42N03-3M9P-GE3